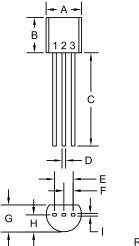
Package Details TO-92 Case





Mechanical Drawing



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Packing Options

Bulk:

White corrugated box with static shielded bags

Bulk Packing Quantity: 2,500

Tape and Reel / Ammo Pack:

Radial taped in accordance with EIA-468-C

Packing Quantity: 2,000

Also available in the following lead form options TO-92-5F, TO-92-5T, TO-92-5T1, TO-92-18F, TO-92-18R

DIMENSIONS								
	INC	HES	MILLIMETERS					
SYMBOL	MIN	MAX	MIN	MAX				
A (DIA)	0.175	0.205	4.45	5.21				
В	0.170	0.210	10 4.32 5.					
С	0.500 - 12		12.70	ı				
D	0.016	0.022	0.41	0.56				
E	0.1	00	2.	54				
F	0.0)50	1.:	27				
G	0.125	0.165	3.18	4.19				
Н	0.080	0.105 2.03		2.67				
	0.0)15	0.	38				

TO-92 (REV: R1)

Lead Code:

SCR*		
1) Anode		1) Cathode
2) Gate	or	2) Gate
3) Cathode		3) Anode

E	E	٦	-*
г	ᆮ		

FET*		
1) Drain		1) Drain
2) Source		2) Gate
3) Gate		3) Source
	or	
1) Gate		1) Source
2) Source		2) Drain
3) Drain		3) Gate
2) Source		2) Drain

PUT	TRIAC
1) Anode	1) MT1
2) Gate	2) Gate
3) Cathode	3) MT2

TRANSISTOR*

1) Emitter	1) Emitter
2) Base	2) Collector
Collector	3) Base
or	
1) Collector	1) Base
2) Base	2) Emitter
3) Emitter	3) Collector

^{*} Note: See individual device datasheet for pinout information.

R1 (8-September 2015)

Package Details - TO-92 TR

Tape and Reel Specifications

1.0. Purpose:

This specification defines the tape and reel packaging requirements for TO-92 devices. Devices supplied to this specification are taped in accordance with Electronic Industries Association Standard EIA-468-C.

2.0 Requirements:

- 2.1 Tape and Reel Requirements: Devices to be taped and reeled in accordance with Figures 2 and 3.
- 2.2 Style Type: A suffix is added to part number to indicate Style Type. Example: CS92B TRE (CS92B taped and reeled in accordance with STYLE E). Note: STYLE E is preferred.
- 2.3 Packaging Base: Devices to be taped 2000 pieces per reel.

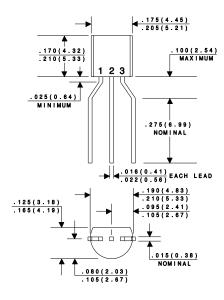


FIGURE 1. PHYSICAL DIMENSIONS ALL DIMENSIONS IN INCHES (mm).



Package Details - TO-92 TR

Tape and Reel Specifications

(Continued)

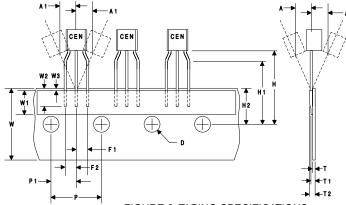


FIGURE 2. TAPING SPECIFICATIONS

		INC	HES	М	М	
SYMBOL	DESCRIPTION	MIN	MAX	MIN	MAX	NOTE
Α	FRONT TO REAR DEFLECTION		0.039		1.0	1
A1	LEFT TO RIGHT DEFLECTION		0.039		1.0	
D	FEED HOLE DIAMETER	0.15	0.17	3.8	4.2	
F1	COMPONENT LEAD PITCH	0.09	0.11	2.4	2.9	6
F2	COMPONENT LEAD PITCH	0.09	0.11	2.4	2.9	6
Н	FEED HOLE TO BOTTOM OF COMPONENT	0.75	0.79	19.0	20.0	
H1	HEIGHT OF SEATING PLANE	0.61	0.65	15.5	16.5	2
H2	HEIGHT OF FEED HOLE LOCATION	0.33	0.37	8.5	9.5	7,8
Р	FEED HOLE PITCH	0.49	0.51	12.5	12.9	3
P1	CENTER OF SEATING PLANE LOCATION	0.23	0.26	5.95	6.75	
Т	CARRIER TAPE THICKNESS	0.015	0.027	0.38	0.68	4
T1	OVERALL TAPE THICKNESS	0.020	0.035	0.50	0.90	
T2	TOTAL TAPED PACKAGE THICKNESS		0.057		1.44	4
W	CARRIER TAPE WIDTH	0.69	0.75	17.5	19.0	
W1	ADHESIVE TAPE WIDTH	0.20	0.28	5.0	7.0	5
W2	LEAD ENCLOSURE	0.18		4.5		
W3	ADHESIVE TAPE POSITION		0.020		0.5	5

NOTES:

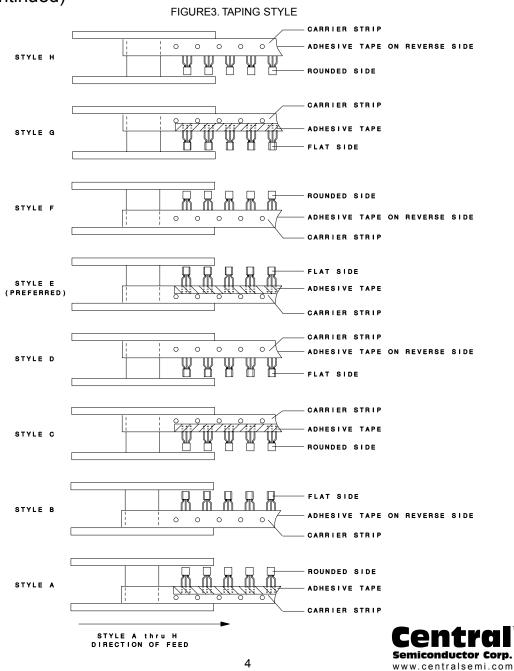
- 1) MAXIMUM ALIGNMENT DEVIATION BETWEEN LEADS NOT TO BE GREATER THAN 0.2mm.
- MAXIMUM CUMULATIVE VARIATION BETWEEN TAPE FEED HOLES SHALL NOT EXCEED 1.0mm IN 20 PITCHES.

 OVERALL TAPED PACKAGE THICKNESS, INCLUDING COMPONENT LEADS AND TAPE SPLICES SHALL NOT EXCEED 1.44mm.
- HOLDDOWN TAPE NOT TO EXTEND BEYOND THE EDGES OF CARRIER TAPE AND THERE SHALL BE NO EXPOSURE OF ADHESIVE.
- 6) NO MORE THAN 0.1% MISSING AND NO CONSECUTIVE MISSING COMPONENTS PER REEL IS PERMITTED. 7) A TAPE LEADER AND TRAILER, HAVING AT LEAST 3 SPROCKET HOLES IS REQUIRED.
- 8) NO MORE THAN 10 SPLICES PER REEL IS PERMITTED AND SPLICES SHALL NOT INTERFERE WITH SPROCKET FEED HOLES.



Package Details - TO-92 TR

Tape and Reel Specifications (Continued)



Package Details - TO-92 AP

Ammopack

Specifications

1.0. PURPOSE:

This specification defines the TO-92 Ammopack requirements. Devices supplied to this specification are taped in accordance with Electronic Industries Association Standard EIA-468-C.

2.0 REQUIREMENTS:

- 2.1 Tape Requirements: Devices to be taped in accordance with Figure 2.
- 2.2 Style Type: STYLE M (PREFERRED) or STYLE P (See Figures 3 and 4).
- 2.3 Ordering Info: Add suffix to part number to indicate Style Type .
 Suffix APM For STYLE M (Equivalent to reel pack STYLE E).
 Example: CS92B APM (CS92B SCR, Ammopack STYLE M).
 or
 - Suffix APP For STYLE P (Equivalent to reel pack STYLE A). Example: CS92B APP (CS92B SCR, Ammopack STYLE P).
- 2.4 Packaging Base: Devices to be taped 2000 pieces per Ammopack.

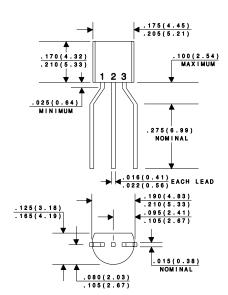


FIGURE 1. PHYSICAL DIMENSIONS All Dimensions in Inches (mm)



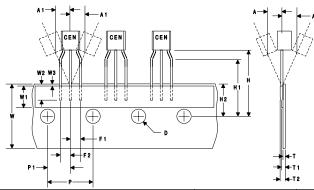
Package Details - TO-92 AP

TO-92 Ammopack

Specifications

(Continued)

FIGURE 2. (TAPING SPECIFICATIONS)



		INC	HES	М	MM	
SYMBOL	DESCRIPTION	MIN	MAX	MIN	MAX	NOTE
Α	FRONT TO REAR DEFLECTION		0.039		1.0	1
A1	LEFT TO RIGHT DEFLECTION		0.039		1.0	
D	FEED HOLE DIAMETER	0.15	0.17	3.8	4.2	
F1	COMPONENT LEAD PITCH	0.09	0.11	2.4	2.9	6
F2	COMPONENT LEAD PITCH	0.09	0.11	2.4	2.9	6
Н	FEED HOLE TO BOTTOM OF COMPONENT	0.75	0.79	19.0	20.0	
H1	HEIGHT OF SEATING PLANE	0.61	0.65	15.5	16.5	2
H2	HEIGHT OF FEED HOLE LOCATION	0.33	0.37	8.5	9.5	7,8
Р	FEED HOLE PITCH	0.49	0.51	12.5	12.9	3
P1	CENTER OF SEATING PLANE LOCATION	0.23	0.26	5.95	6.75	
Т	CARRIER TAPE THICKNESS	0.015	0.027	0.38	0.68	4
T1	OVERALL TAPE THICKNESS	0.020	0.035	0.50	0.90	
T2	TOTAL TAPED PACKAGE THICKNESS		0.057		1.44	4
W	CARRIER TAPE WIDTH	0.69	0.75	17.5	19.0	
W1	ADHESIVE TAPE WIDTH	0.20	0.28	5.0	7.0	5
W2	LEAD ENCLOSURE	0.18		4.5		
W3	ADHESIVE TAPE POSITION		0.020		0.5	5

NOTES:

- 1) MAXIMUM ALIGNMENT DEVIATION BETWEEN LEADS NOT TO BE GREATER THAN 0.2mm.
 - AS ILLUSTRATED, THE CLEARANCE TO THE LEAD STANDOFF FORM SHALL BE DEFINED TO THE POINT OF RADIUS FOR THE STANDOFF FORM.
 MAXIMUM CUMULATIVE VARIATION BETWEEN TAPE FEED HOLES SHALL NOT EXCEED 1.0mm IN 20 PITCHES.
 OVERALL TAPED PACKAGE THICKNESS, INCLUDING COMPONENT LEADS AND TAPE SPLICES SHALL NOT EXCEED 1.44mm.

 - 5) HOLDDOWN TAPE NOT TO EXTEND BEYOND THE EDGES OF CARRIER TAPE AND THERE SHALL BE NO EXPOSURE OF ADHESIVE.
 - 6) NO MORE THAN 0.1% MISSING AND NO CONSECUTIVE MISSING COMPONENTS PER REEL IS PERMITTED. 7) A TAPE LEADER AND TRAILER, HAVING AT LEAST 3 SPROCKET HOLES IS REQUIRED.

 - 8) NO MORE THAN 10 SPLICES PER REEL IS PERMITTED AND SPLICES SHALL NOT INTERFERE WITH SPROCKET FEED HOLES.



Package Details - TO-92 AP

Ammopack

Specifications (Continued)

FIGURE 3. STYLE M (PREFERRED)

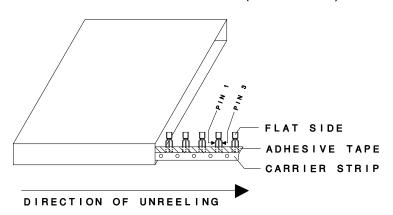
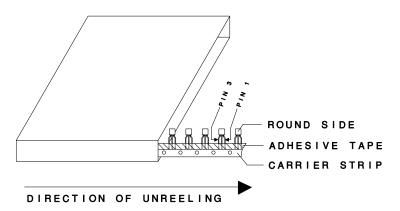


FIGURE 4. STYLE P



Note: The box is accessible from either side depending upon whether PIN 1 or PIN 3 is required at the leading edge.



Material Composition Specification

TO-92 Case





Eutectic Die Attach

Device average mass 206 mg (+/-10%)

0	Material	Mat	erial	0	CAS No		Substance		
Component	Material	(%wt)	(mg)	Substance	CAS No.	(%wt)	(mg)	(ppm)	
active device	doped Si	0.034%	0.07	Si	7440-21-3	0.034%	0.07	340	
bond wire		0.016%	0.032	Au	7440-57-5	0.0469/	0.032	155	
	gold or copper	0.016%	0.032	Cu	7440-50-8	0.016%	0.032	155	
				Cu	7440-50-8	44.641%	91.96	446,408	
leadframe	Cu alloy	44.824%	92.338	Fe	7439-89-6	0.045%	0.092	447	
leadirame	w/ silver plating	44.024%	92.336	Р	7723-14-0	0.016%	0.032	155	
				Ag	7440-22-4	0.123%	0.254	1,233	
				silica	7631-86-9	40.694%	83.83	406,942	
			107.71	epoxy resin	29690-82-2	5.267%	10.85	52,670	
	EMC	52.286%		phenol resin	9003-35-4	4.748%	9.78	47,476	
	EIVIC			carbon black	1333-86-4	0.149%	0.306	1,485	
				Sb ₂ O ₃	1309-64-4	1.146%	2.36	11,456	
encapsulation*				TBBA	79-94-7	0.283%	0.584	2,835	
				silica	7631-86-9	38.816%	79.96	388,155	
				epoxy resin	29690-82-2	5.024%	10.35	50,243	
	EMC GREEN	52.286%	107.71	phenol resin	9003-35-4	4.529%	9.33	45,291	
				carbon black	1333-86-4	0.568%	1.17	5,680	
				metal hydroxide	1309-42-8	3.35%	6.9	33,495	
	him/lood masses	2.040/	E 0E	Sn	7440-31-5	2.282%	4.7	22,816	
plating**	tin/lead process	2.84%	5.85	Pb	7439-92-1	0.558%	1.15	5,583	
_	matte tin	2.84%	5.85	Sn	7440-31-5	2.84%	5.85	28,398	

Epoxy Die Attach

Device average mass 206 mg (+/-10%)

				•		<u> </u>			
0	Material	Material		Substance	CAS No.		Substance		
Component	Wateriai	(%wt)	(mg)	Substance	CAS No.	(%wt)	(mg)	(ppm)	
active device	doped Si	0.035%	0.07	Si	7440-21-3	0.035%	0.073	354	
bond wire	and discourage	0.0460/	0.032	Au	7440-57-5	0.0400/	0.000	455	
bond wire	gold or copper	0.016%	0.032	Cu	7440-50-8	0.016%	0.032	155	
				Cu	7440-50-8	44.64%	91.96	446,408	
la a dfua us a	Cu alloy	44.82%	92.34	Fe	7439-89-6	0.045%	0.092	447	
leadframe	w/ silver plating	44.02%	92.34	Р	7723-14-0	0.016%	0.032	155	
				Ag	7440-22-4	0.123%	0.254	1,233	
				Pb	7439-92-1	0.113%	0.232	1,126	
die attach	silver epoxy	0.121%	0.25	Sn	7440-31-5	0.006%	0.012	58	
				Ag	7440-22-4	0.003%	0.006	29	
	EMC	52.16%	107.46	silica	7631-86-9	40.6%	83.64	406,019	
				epoxy resin	29690-82-2	5.25%	10.82	52,524	
				phenol resin	9003-35-4	4.74%	9.76	47,379	
	EIVIC	32.10%		carbon black	1333-86-4	0.148%	0.305	1,481	
				Sb ₂ O ₃	1309-64-4	1.14%	2.35	11,408	
encapsulation*				TBBA	79-94-7	0.283%	0.582	2,825	
				silica	7631-86-9	38.72%	79.77	387,233	
				epoxy resin	29690-82-2	5.015%	10.33	50,146	
	EMC GREEN	52.16%	107.46	phenol resin	9003-35-4	4.519%	9.31	45,194	
				carbon black	1333-86-4	0.567%	1.167	5,665	
				metal hydroxide	1309-42-8	3.34%	6.88	33,398	
	tin/load process	2.84%	5.85	Sn	7440-31-5	2.282%	4.7	22,816	
plating**	tin/lead process	2.04%	3.65	Pb	7439-92-1	0.558%	1.15	5,583	
	matte tin	2.84%	5.85	Sn	7440-31-5	2.84%	5.85	28,398	

^{*}EMC GREEN molding compound is Halogen-Free.

The information provided in this Material Composition data sheet is, to the best of our knowledge, correct. However, there is no guarantee to completeness or accuracy, as some information is derived from data sources outside the company.

R7 (27-February 2020)

^{**}For Lead Free plating, add suffix "PB FREE" to part number.

For Tin/Lead plating, add suffix "TIN/LEAD" to part number.

No suffix designation allows for the supply of either lead-free or tin/lead plated product depending on availability.